

Vishay Siliconix

Dual N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^d	Q _g (Typ.)			
30	0.040 at V _{GS} = 10 V	5.8	2.8 nC			
30	$0.050 \text{ at V}_{GS} = 4.5 \text{ V}$	5.5	2.0110			

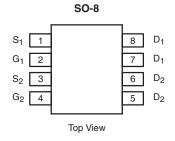
FEATURES

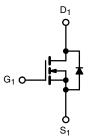
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET

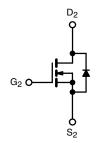
ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Low Current DC/DC Conversion
- Notebook System Power







Ordering Information: Si4936CDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	30	V		
Gate-Source Voltage	V _{GS}	± 20	v		
	T _C = 25 °C	I _D	5.8		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C		4.6		
Continuous Drain Current (1, = 150°C)	T _A = 25 °C		5.0 ^{a, b}		
	T _A = 70 °C		4.0 ^{a, b}	Α	
Pulsed Drain Current	I _{DM}	20			
Continuous Course Drain Diada Current	T _C = 25 °C	- I _S	1.9		
Continuous Source-Drain Diode Current	T _A = 25 °C		1.4 ^{a, b}		
	T _C = 25 °C		2.3		
Manipulas Davies Discipation	T _C = 70 °C	P _D	1.5	w	
Maximum Power Dissipation	T _A = 25 °C		1.7 ^{a, b}	VV	
	T _A = 70 °C	1	1.1 ^{a, b}		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	58	75	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	42	55	O/VV		

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 110 °C/W.
- d. Based on T_C = 25 °C.

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SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				ı	1		
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		32		1406	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- '		- 5		mV/°C	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.2		3	V	
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zoro Coto Voltago Proin Current	ı	V _{DS} = 30 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 30 V, V_{GS} = 0 V, T_J = 55 °C	°C		10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	15			Α	
		$V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		0.033	0.040		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 4.7 \text{ A}$		0.041	0.050	Ω	
Forward Transconductance ^a	g _{fs}	$V_{DS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		15		S	
Dynamic ^b					l	<u> </u>	
Input Capacitance	C _{iss}			325			
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		60		pF	
Reverse Transfer Capacitance	C _{rss}			30			
<u> </u>		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		6 9			
Total Gate Charge	Q _g	20 40 2		2.8	4.2	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$		1.1			
Gate-Drain Charge	Q _{gd}			0.8			
Gate Resistance	R _g	f = 1 MHz	0.6	2.8	5.6	Ω	
Turn-On Delay Time	t _{d(on)}			12	18		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_1 = 3.8 \Omega$		13	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 4 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		16	25		
Fall Time	t _f	•		11	17		
Turn-On Delay Time	t _{d(on)}			4	8	ns	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_1 = 3.8 \Omega$		9	18	- - -	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 4 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 1 \Omega$		11	20		
Fall Time	t _f	· •		8	15		
Drain-Source Body Diode Characteristic	· ·						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			1.9	Ι.	
Pulse Diode Forward Current	I _{SM}				20	A	
Body Diode Voltage	V _{SD}	I _S = 4 A, V _{GS} = 0 V		0.8	1.2	٧	
Body Diode Reverse Recovery Time	t _{rr}			11	20	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			4	8	nC	
Reverse Recovery Fall Time	t _a	$I_F = 4$ A, $dI/dt = 100$ A/ μ s, $T_J = 25$ °C		6	-	<u> </u>	
Reverse Recovery Rise Time	t _b	_		5		ns	

Notes:

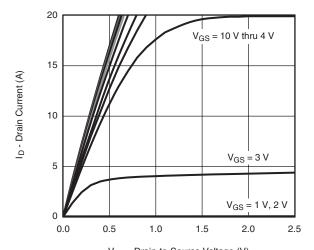
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

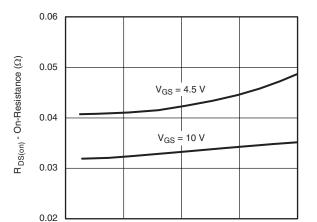


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



V_{DS} - Drain-to-Source Voltage (V) **Output Characteristics**



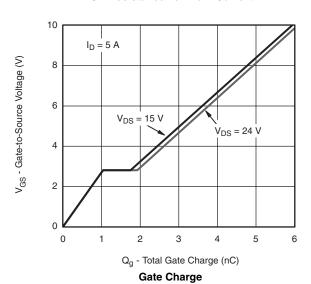
I_D - Drain Current (A)

On-Resistance vs. Drain Current

10

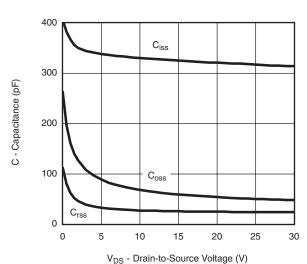
20

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(v) to an original of the second of the seco

V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**



1.7 $V_{GS} = 10 \text{ V}; I_D = 5 \text{ A}$ 1.5 R_{DS(on)} - On-Resistance (Normalized) 1.3 $V_{GS} = 4.5 \text{ V};$ $I_D = 4.7 \text{ A}$ 1.1 0.9 0.7 - 50 - 25 25 50 75 100 125 T_J - Junction Temperature (°C)

Capacitance

On-Resistance vs. Junction Temperature

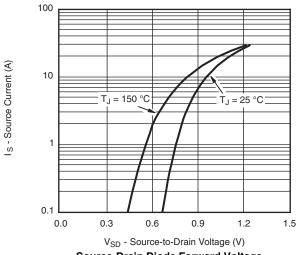
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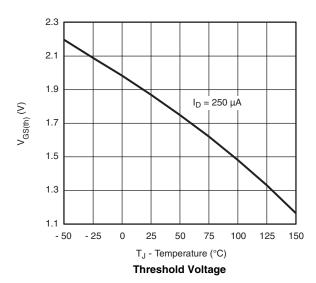
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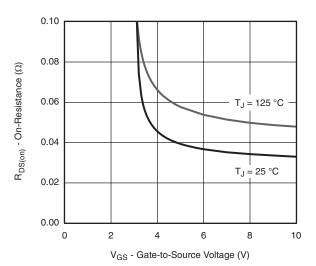
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

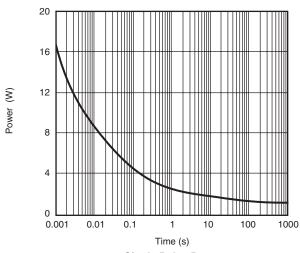


Source-Drain Diode Forward Voltage

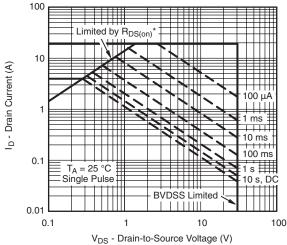




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power

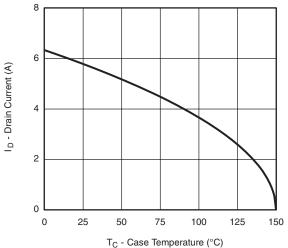


* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

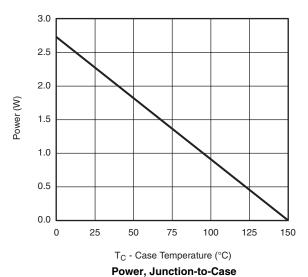
Safe Operating Area, Junction-to-Ambient

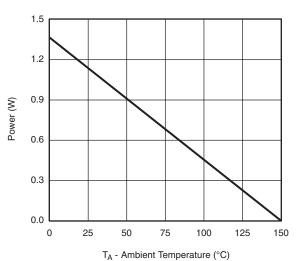
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*





Power, Junction-to-Ambient

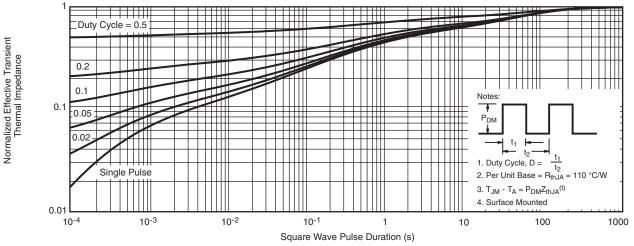
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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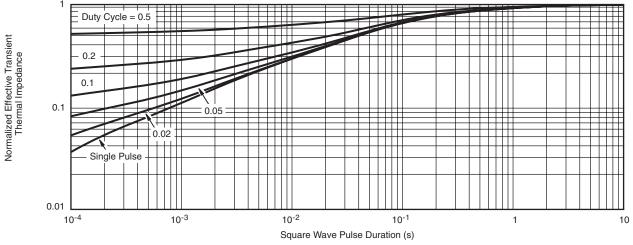
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?69097.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	INCHES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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Revision: 13-Jun-16 1 Document Number: 91000

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